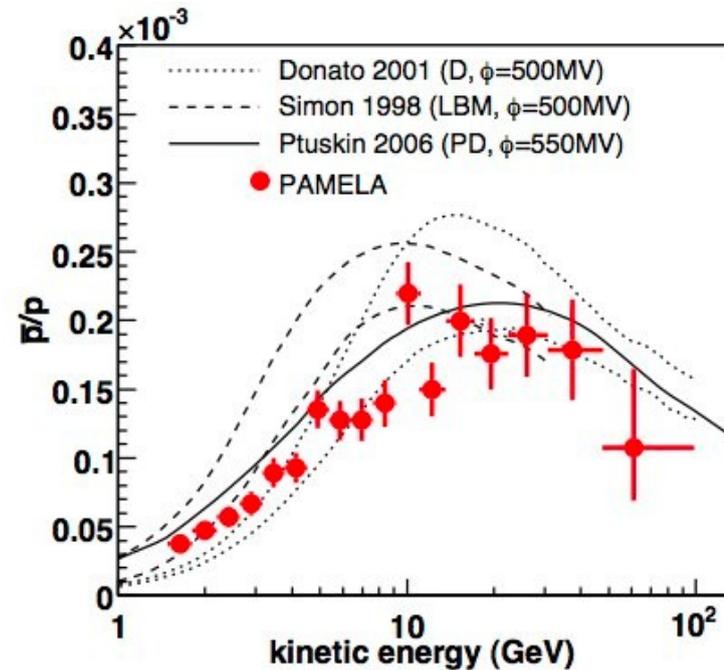
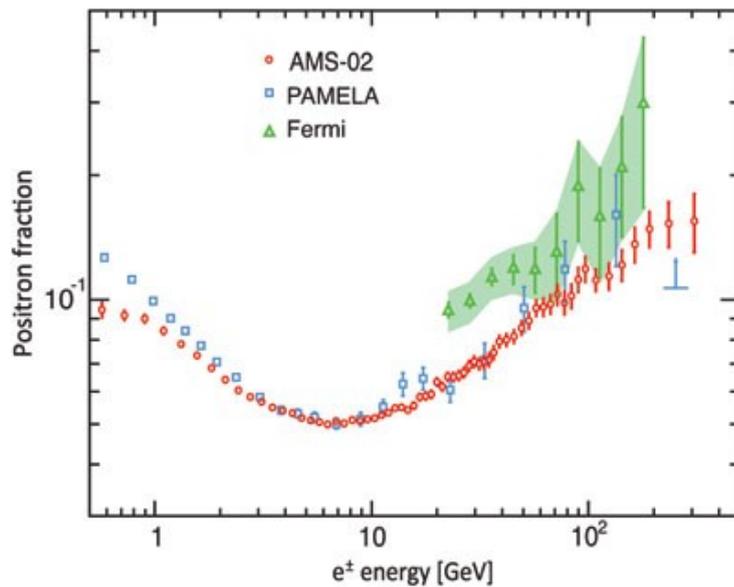
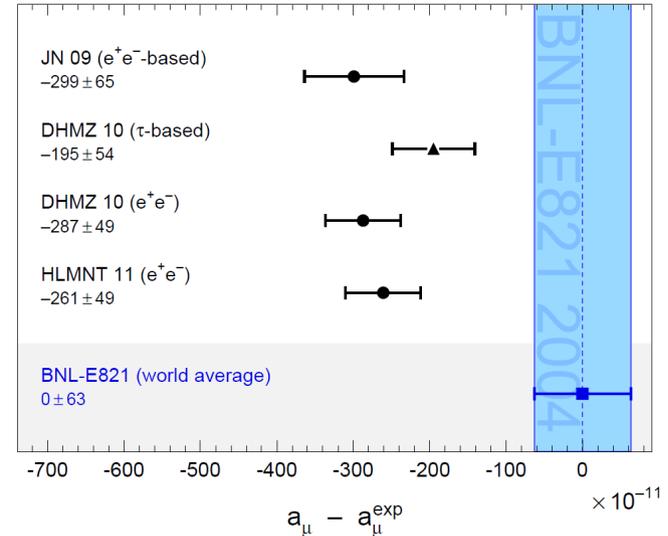




G.Simi
Consiglio di sezione INFN Padova
1/7/2013

Motivation

- Positron excess in PAMELA/AMS data
 - Difficult to explain by thermal DM annihilation
- $g_\mu - 2$ anomaly
- DAMA/LIBRA modulation
- 511KeV line from galactic center
- Muonic hydrogen lamb shift

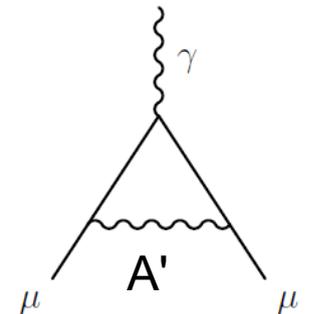
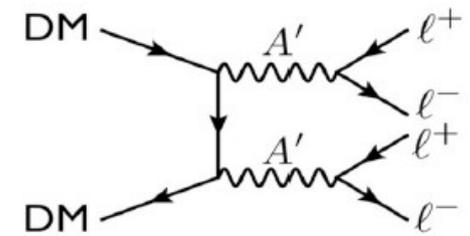
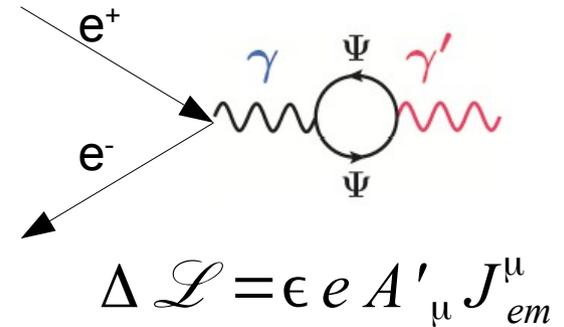
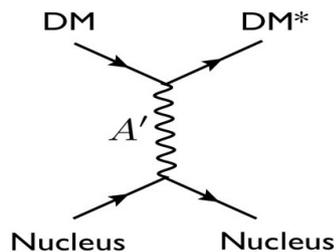


Hidden sector

- New U(1)' gauge symmetry \Rightarrow A' gauge boson
- Absence of anomaly in anti-protons
 - $M_{A'} < 1\text{GeV}$
- Beam dump searches
 - $M_{A'} > 20\text{MeV}$
- Decay into leptons
 - Coupling to SM through kinetic mixing $\epsilon \sim 10^{-2} - 10^{-6}$

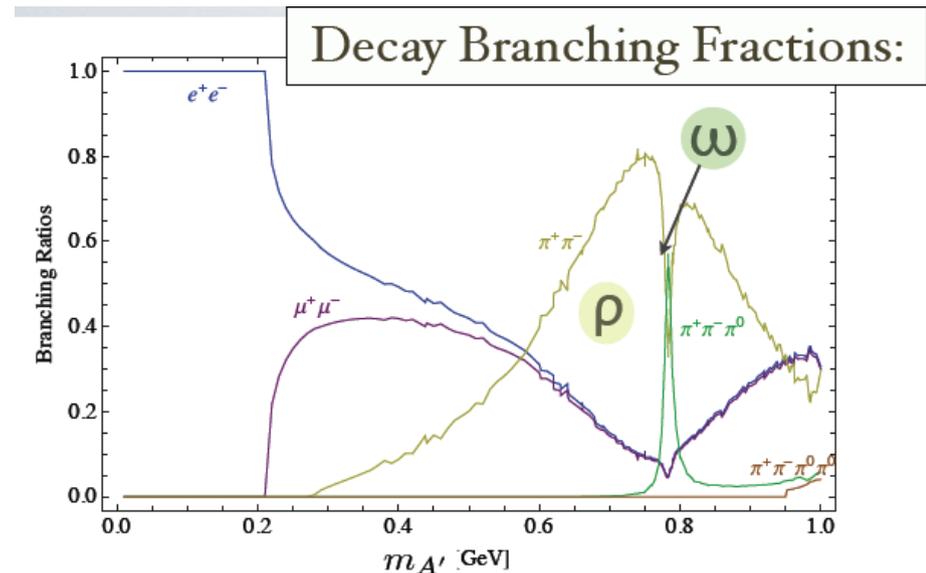
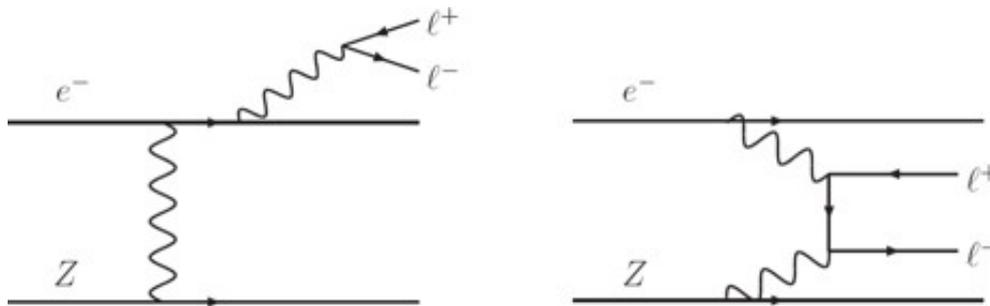
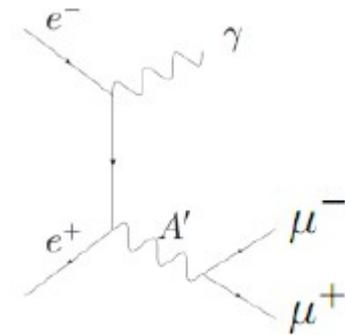
[Holdom, Phys. Lett B166, 1986]

- Positron excess could be explained by DM annihilation into hidden sector photons, g_μ -2 anomaly by a modification of the vertex diagram (PRD79,015014 PLB671,391)
- DM signal in DAMA/LIBRA from inelastic scattering via A' exchange



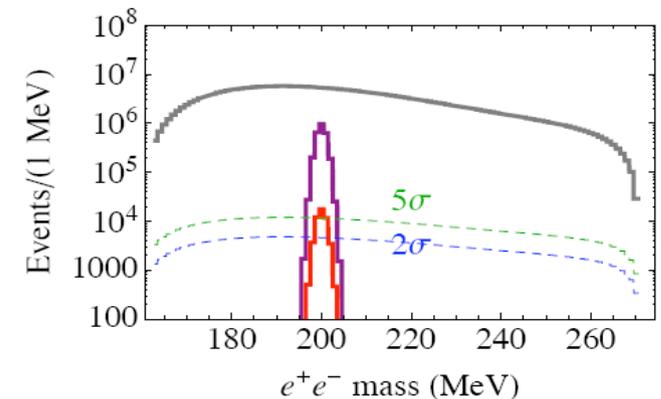
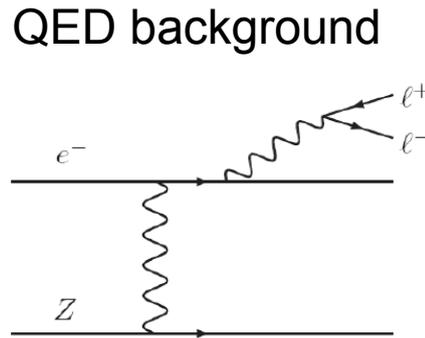
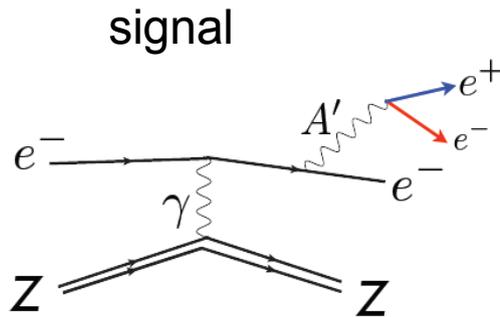
How to search for heavy photons

- in e^+e^- annihilations: Babar, Belle, KLOE
- Electro-production in fixed target experiments
 - Proposed by D.Bjorken et. al. Phys. Rev. D80, 2009,075018

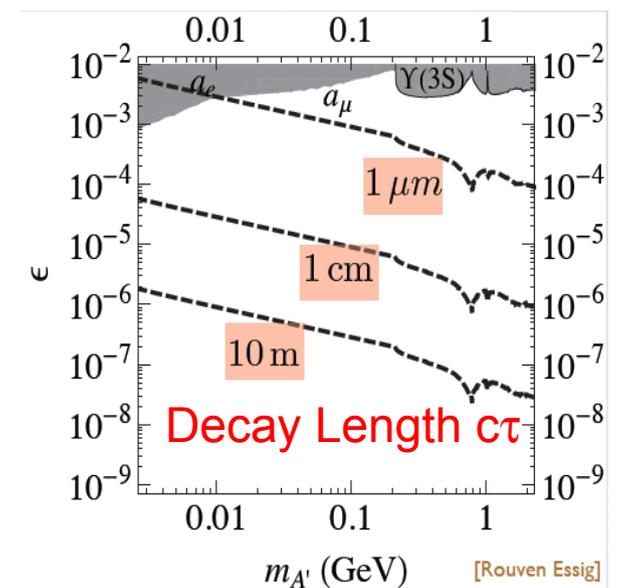
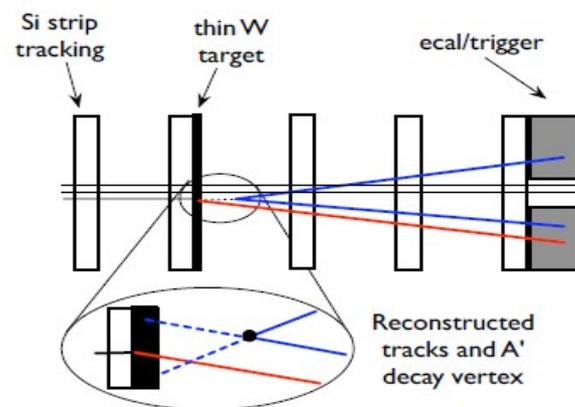


Signatures

- Invariant mass peak over a copious QED background

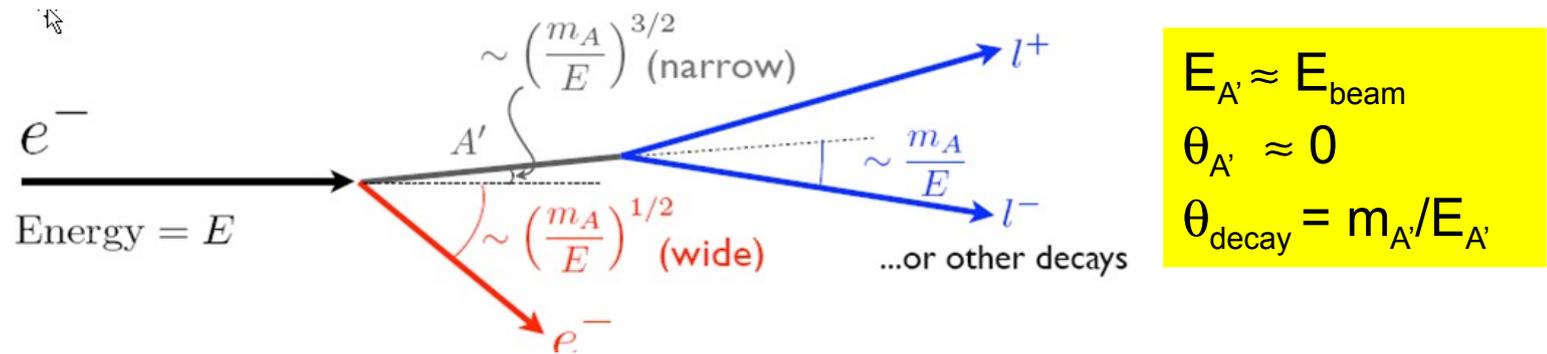


- Detached decay vertex



HPS Design

- A' kinematics \Rightarrow need good forward coverage down to $\sim \theta_{\text{decay}}/2$. This puts detectors close to the beam.



- Vertexing A' decays requires detectors close to the target. Bump hunting needs good momentum/mass resolution. Both need tracking and a magnet.

Want $\Delta m/m \sim 1\%$ for bump hunt

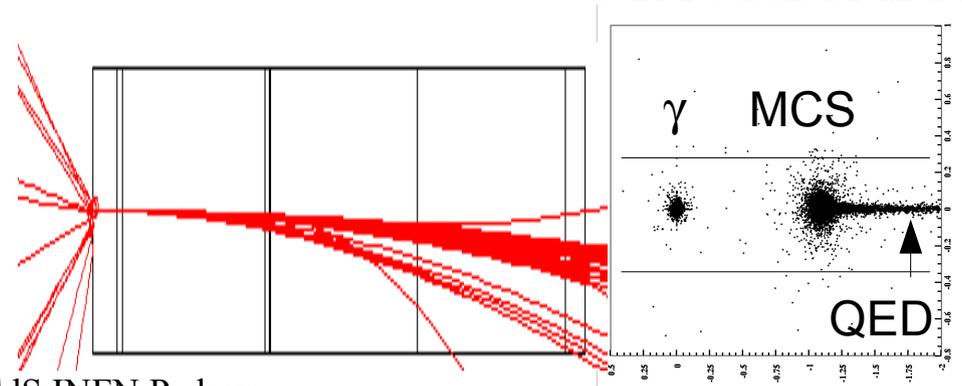
Want $\Delta z \sim 1\text{mm}$

Beam's Eye View

e^+ and e^-

entering ECal

- Trigger with a high rate Electromagnetic Calorimeter downstream of the magnet to select e^+ and e^- .

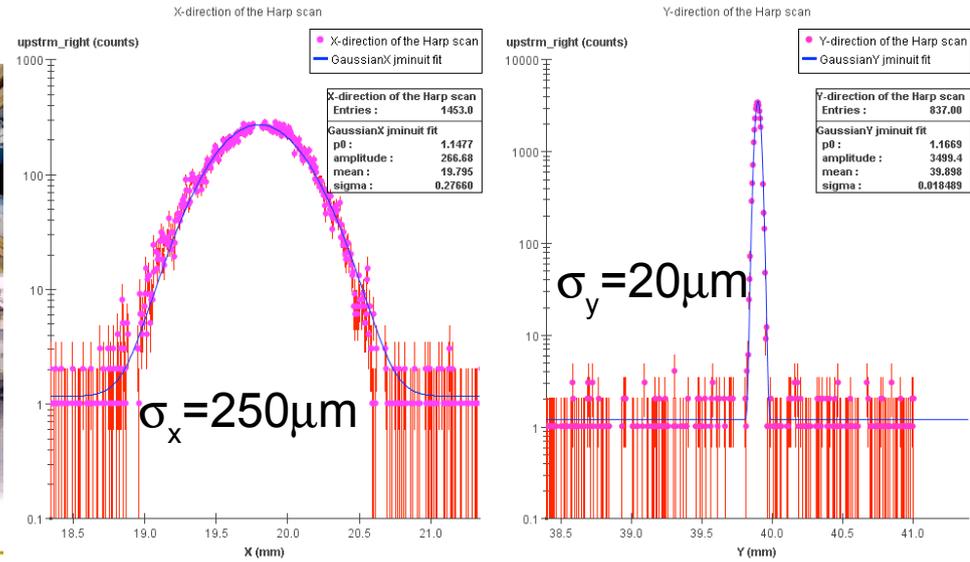
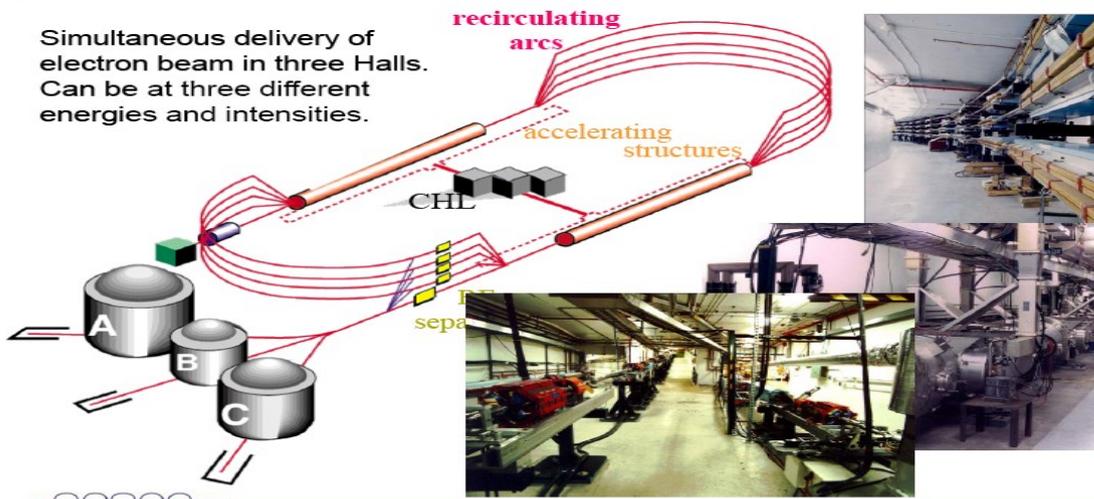


- Beam, QED and Multiple Coulomb Scattering background in the bending plane \Rightarrow split detectors

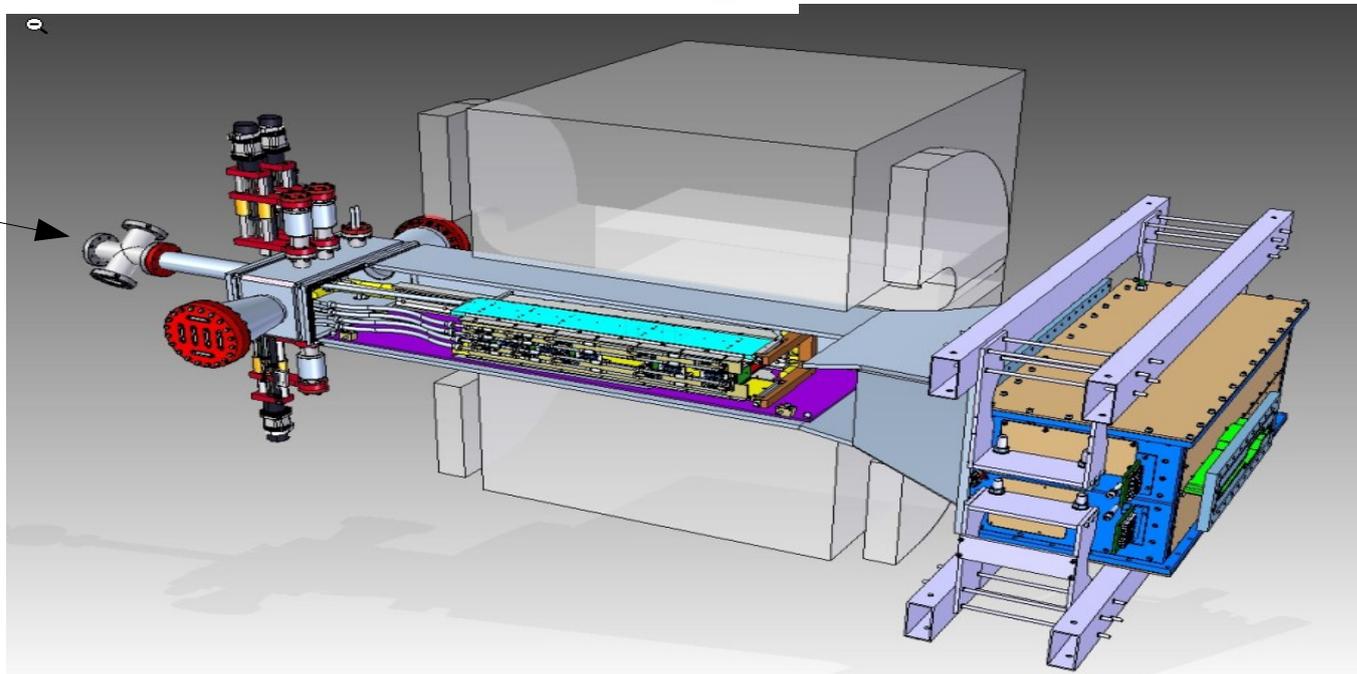
Installed detector

CEBAF - Continuous Electron Beam Accelerator Facility

Simultaneous delivery of electron beam in three Halls. Can be at three different energies and intensities.

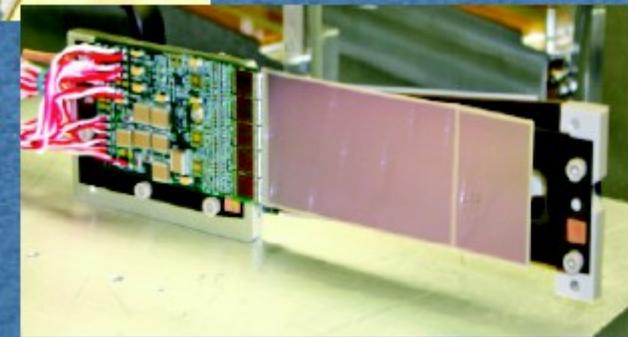
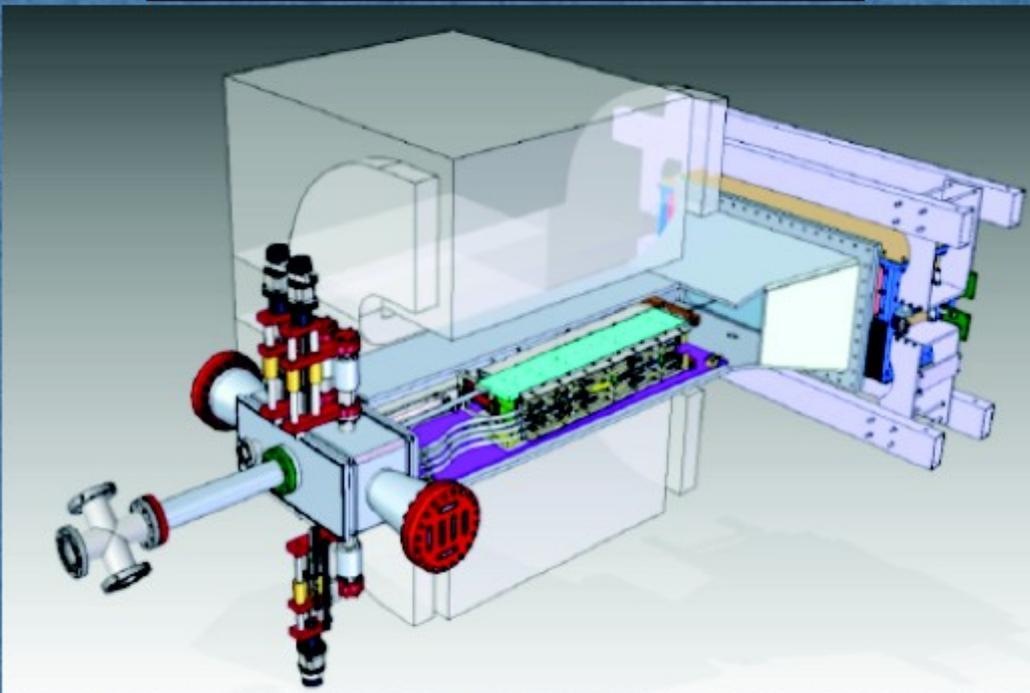
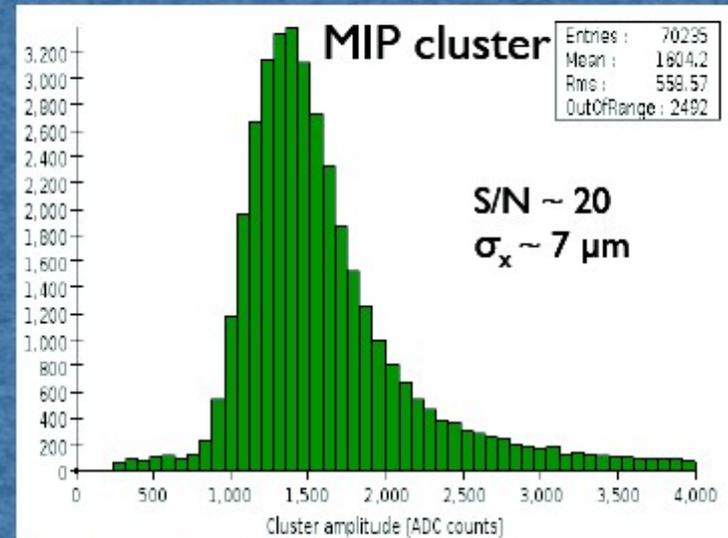


Beam



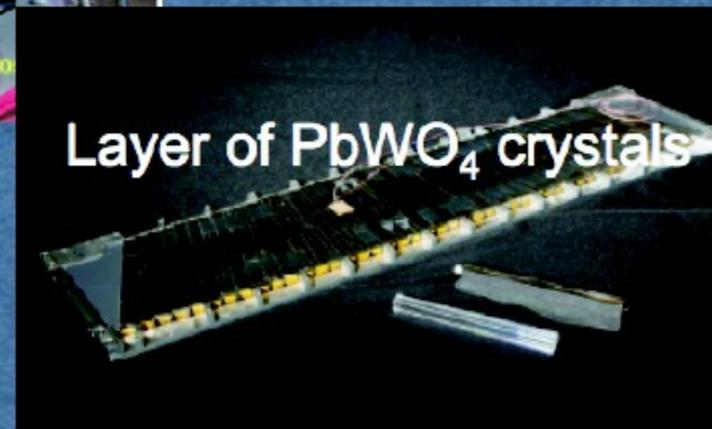
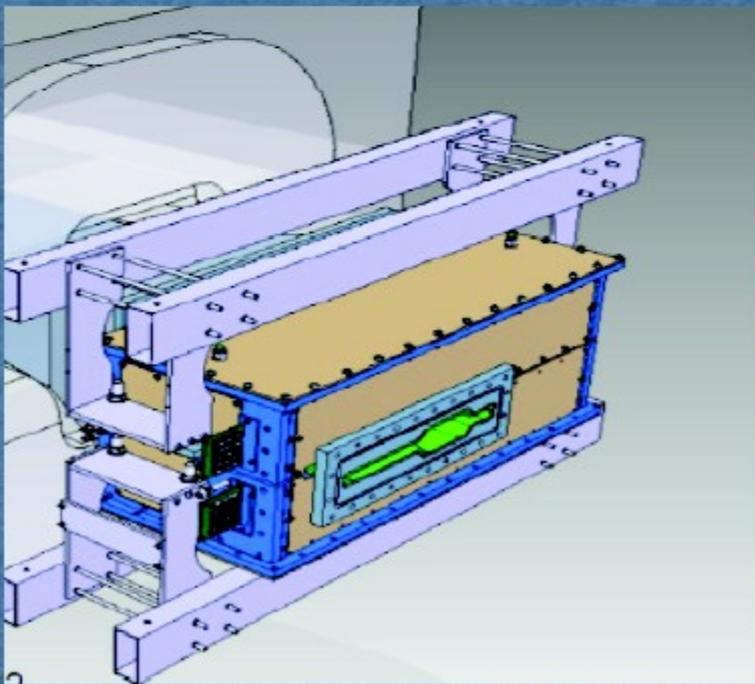
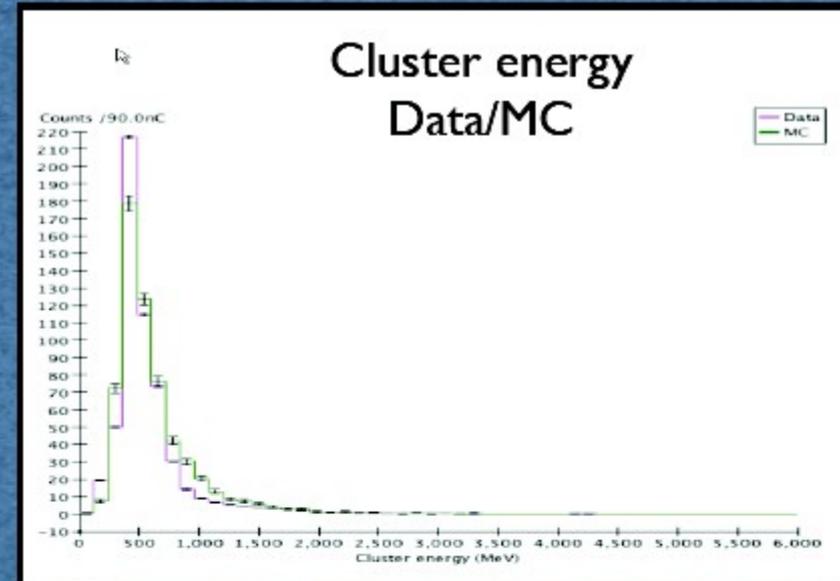
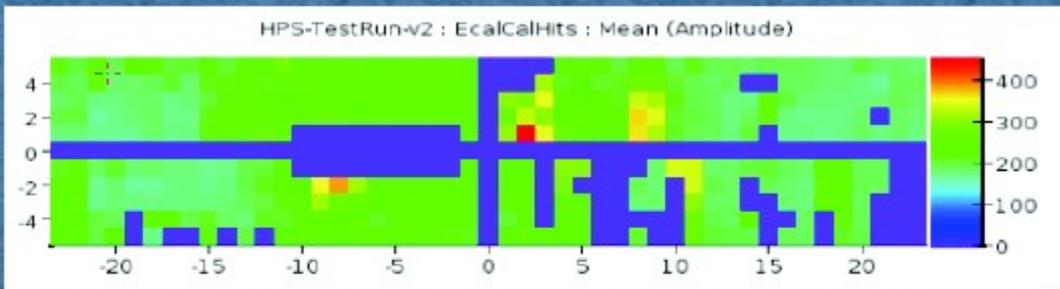
Silicon Vertex Tracker (SVT)

- 5 layers (axial+stereo), microstrip in vacuum
- Split top/bottom to avoid beam and wall of flame
- 0.5Tm pair spectrometer magnet
- Spatial Res: $\sim 6 \mu\text{m}$
- Time resolution $\sim 2\text{-}3 \text{ ns}$
- CMS APV25 readout (40MHz readout)



Electromagnetic Calorimeter

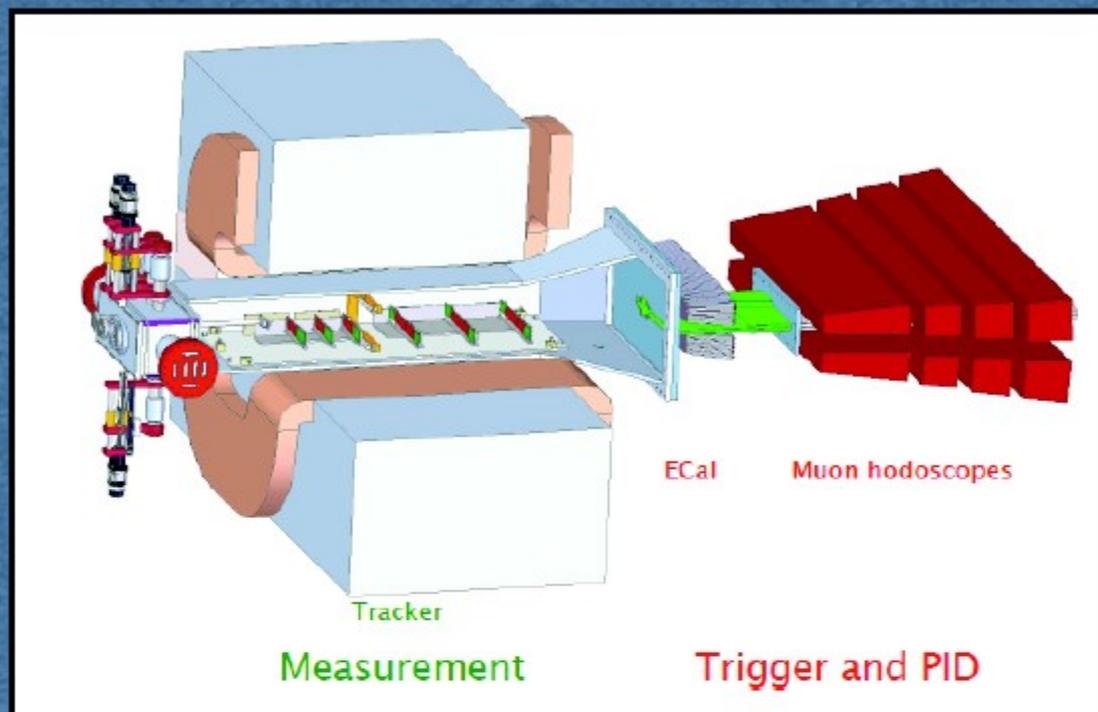
- 442 PbWO crystals
- APD readout (0.5x0.5 cm²)
- Thermal enclosure stabilized at 0.5 °C
- 15 mrad off beam axis



The INFN commitment in HPS

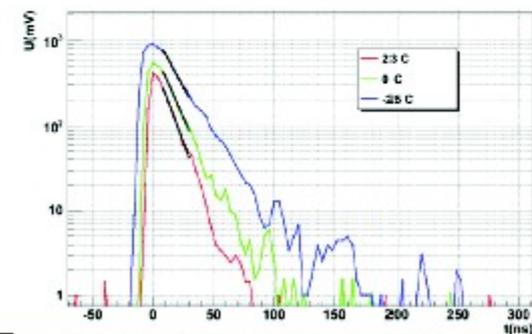
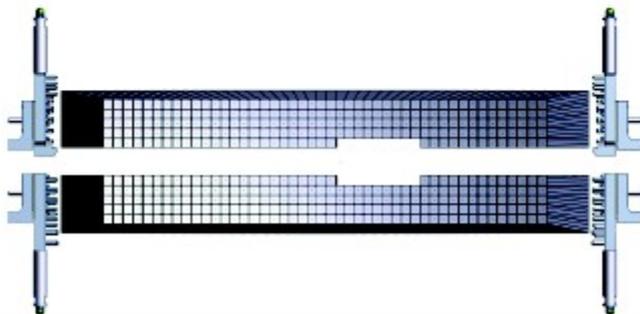


- * Due to our large commitment in the Hall-B Forward Tagger (FT-Cal) we are mainly interested in contributing to the ECal
- * Some solutions have already been tested on FT-Cal design, making our action efficient and effective (hopefully!)
(see A.Celentano talk, later)



HPS ECal

- 442 PbWO crystals
- APD readout (0.5x0.5 cm²)
- Thermal stabilized at 0.5 °C
- 15 mrad off beam axis

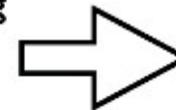


- * Recoil electron detection (see M.Osipenko talks tomorrow)
- * Data analysis (GEMC simulations and ECal reconstruction)

New motherboard (design and construction)

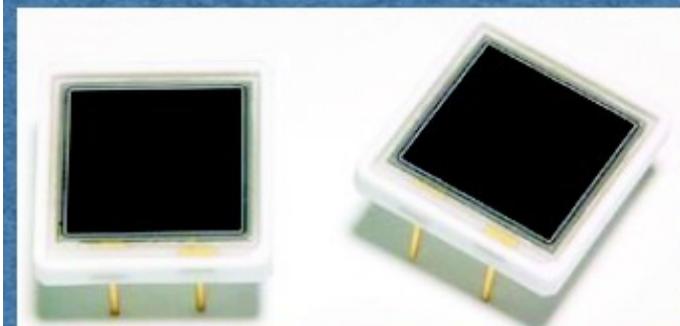
ECal Light Monitoring System (design)

- * Channel matching
- * Check crystal/sensor optical coupling
- * Crystal transparency
- * Gain and stability
- * Front-end electronic linearity

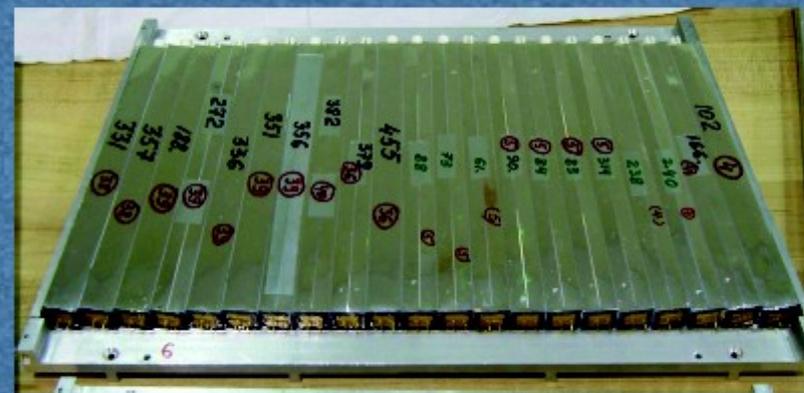
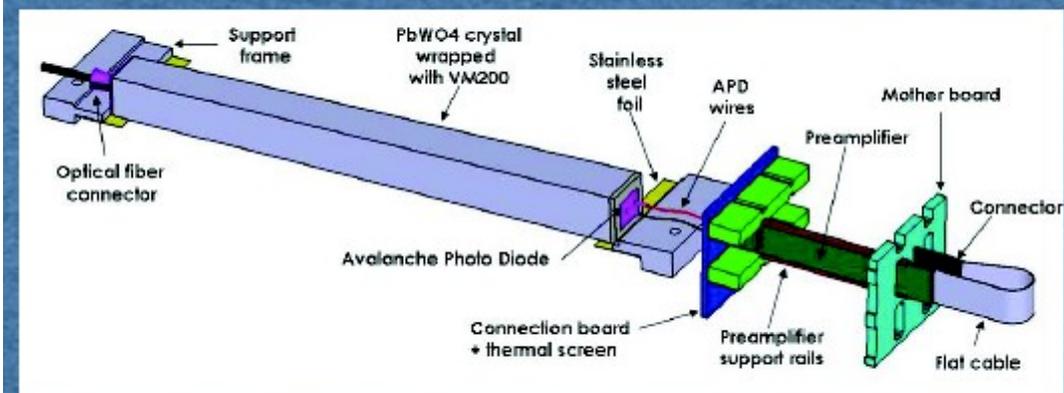


- * Custom circuit from INFN-GE EW
- * Individual blue LED (470nm)
- * All specs fulfilled

Photo sensors (APD)

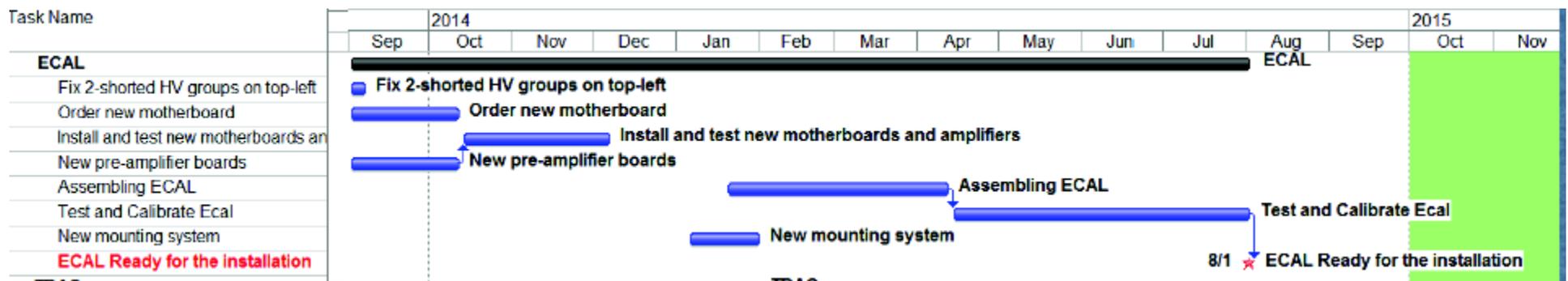


- * New Motherboard design and manufacture
- * ECal LMS design
- * Plan to replace the existing APD (CMS-like) with the new LAAPD
- * Qualify the new sensors
- * Replacing old APDs with new

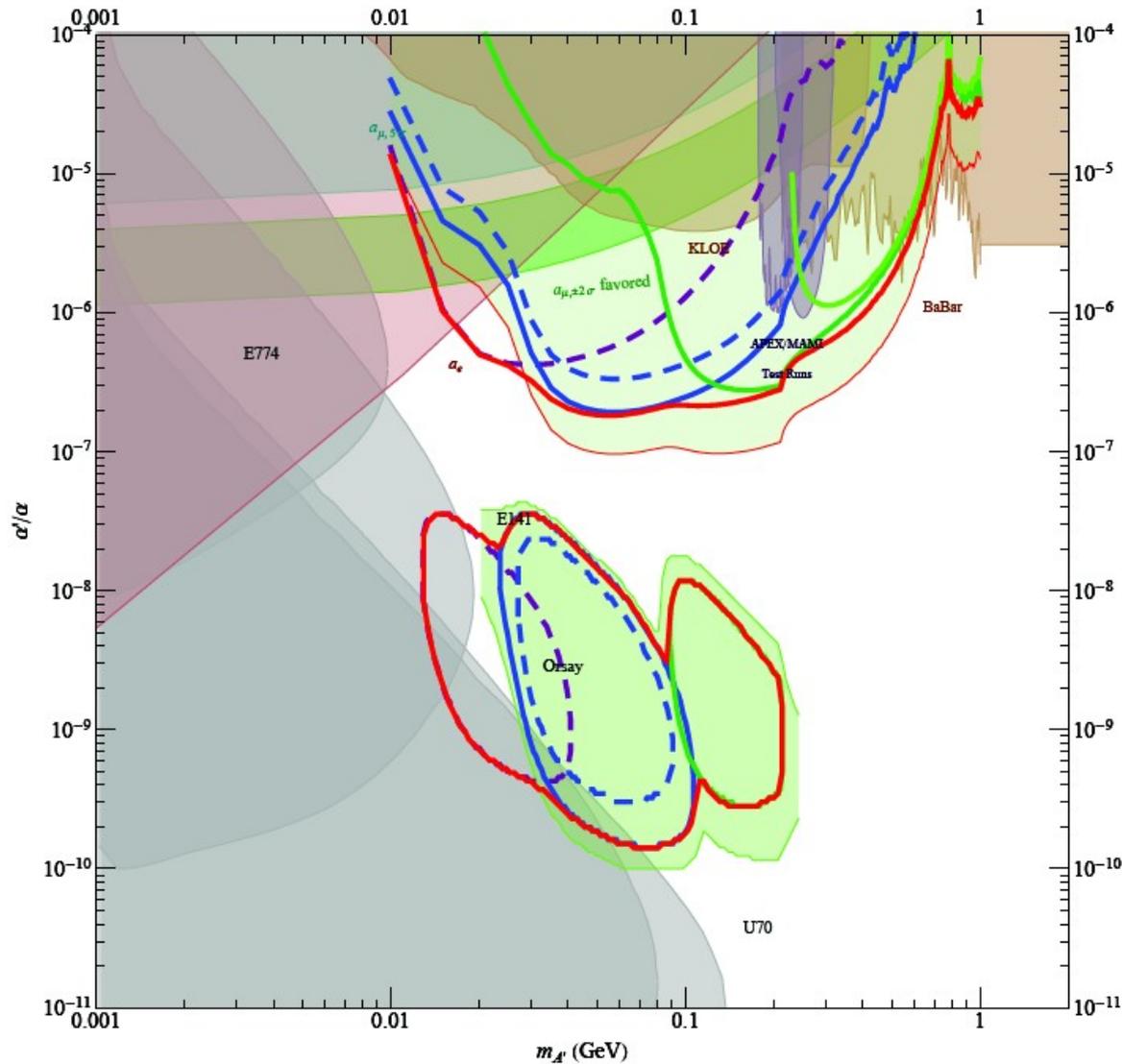


HPS Schedule

- JLab PAC39 approved 6 weeks of running with maximum A-rate
- Installation expected by September 2014
- Data taking expected in Fall 2014 / Spring 2015 (2w commissioning + 4w prod + 18+w prod (??))
- New proposal being submitted to next JLab PAC to obtain a beam time extension



HPS Reach



1w+1w @2.2 GeV

2w+2w @6.6 GeV

@2.2+@6.6 GeV Combined

3m+3m each Combined

INFN Contribution

Budget

INFN contribution

Motherboards (design, production, test)	€10k
LED Light Monitoring System (design)	€5k
Consumables	€3k
TOT	€18k
TOT (VAT+Cont)	€25k

LAAPD (500pcs) Hamamatsu	€215k
Tooling for crystal assembly	€10k
Tooling for APD test	€10k
Shipping	€5k
Consumables	€3k
TOT	€240k
TOT (Cont)	€270k

Secured

**Funding request to INFN
CSNIII in July 13, decision in
September 2013**

**Needs a clear schedule for HPS
run time**

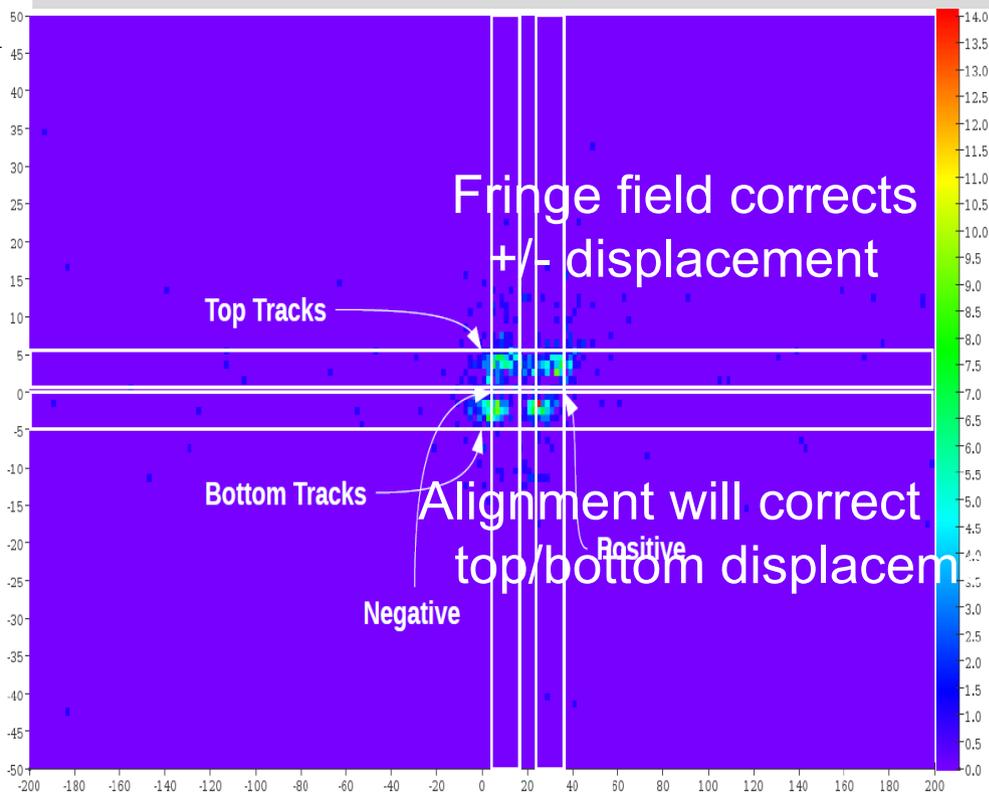
*Needs other 30-40k euro for preamps

**Funds only includes equipment

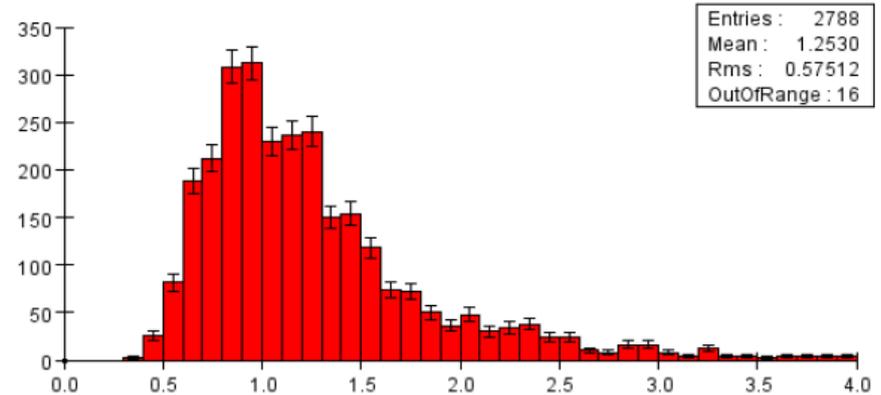
Padova+Cagliari: Tracking Refinements

- Adding magnet fringe fields and improving alignment
- Improving track reconstruction efficiency and purity ($> 90\%$)
- Studies of e^+e^- pairs shown below:

Extrapolated Track Positions at Target
Accurate to few mm

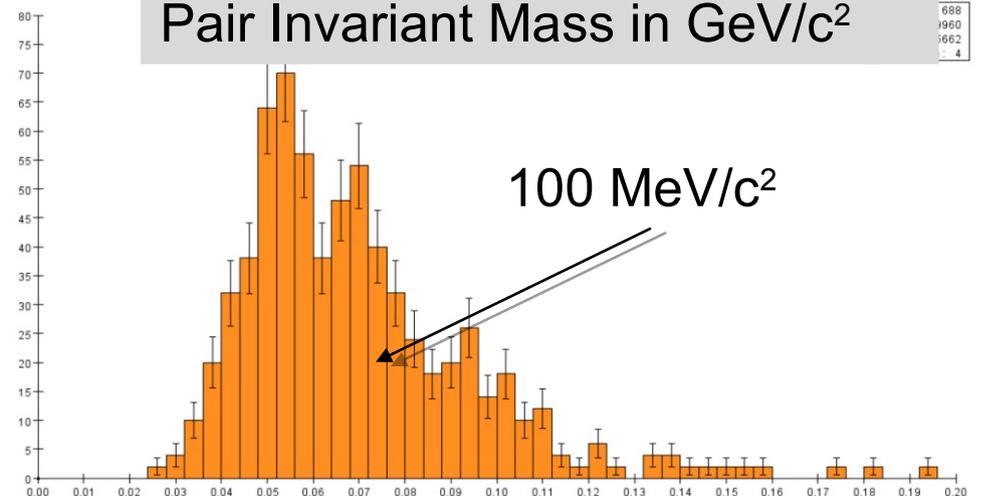


Track Momentum in GeV/c



Invariant Mass

Pair Invariant Mass in GeV/c^2

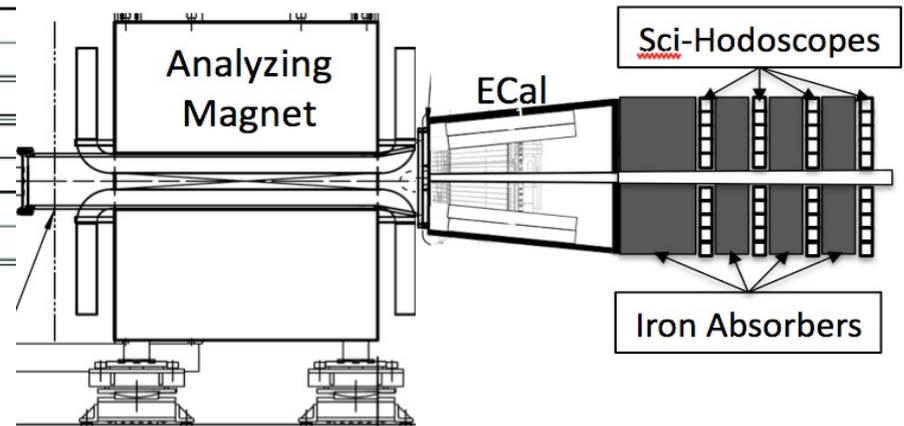


Servizi

- Nessuna richiesta per il momento

Table 3: INFN-JLAB12 manpower commitment.

Activity	INFN-JLAB12 manpower (FTE)	Site
New motherboards design	30 days	Genova
Individual motherboards tests	15 days	Genova
Full motherboard assembly tests		JLAB
LAAPD characterization	40 days	TorVergata
Crystal preparation: tooling	5 days	Genova
Crystal preparation (50 pcs): procedure optimization	5 days	Genova
Crystal preparation (200 pcs): un-gluing and cleaning	15 days	Catania
Crystal preparation (200 pcs): un-gluing and cleaning	15 days	Cagliari
LAAPD glueing: tooling	5 days	Genova
LAAPD glueing (50 pcs): procedure optimization	5 days	Genova
LAAPD glueing (200 pcs)	15 days	Catania
LAAPD glueing (200 pcs)	15 days	Cagliari
Assembly test: tooling	10 days	Genova
Assembly test (50 pcs): procedure optimization	5 days	Genova
Assembly test (200 pcs)	15 days	Catania
Assembly test (200 pcs)	15 days	
Assembly failure	5 days	
Assembly failure	5 days	
Light Monitoring System	30 days	
Total	110 days	
Total	50 days	
Total	50 days	
Total	40 days	



DRAFT